## **DECLARATION AND POWER OF ATTORNEY**

d inventor, I hereby declare that:

\*My residence, post office and citizenship are as stated below next to my name,

names are listed below) or	first and sole inventor (if only one f the subject matter claimed and f FOR UPLINK SYNCHRONOUS	or which a patent is sou	ight on the invention entitled MI	or (11 plural ETHOD OF
[X] is attached hereto an	] was filed on	as Application Seria (if applicabl	l Noand was le)	
I hereby state that I have amended by any amendme	reviewed and understand the connt referred to above.	tents of the above iden	tified specification, including the	e claims, as
I acknowledge the duty to Code of Federal Regulation	disclose information which is knowns, Section 1.56(a).	wn to me to be material	to patentability in accordance w	ith Title 37,
certificate, or 365(a) of an America, listed below and	ority benefits under 35 U.S.C. 1190 by PCT international application well have also identified below, by international application having a firm	which designated at least checking the box, any	one country other than the Unite foreign application for patent of	ed States of or inventor's
Prior Foreign Application	n(s):		Foreign Filing Date	
Number	<u>Country</u> Korea		Month/Day/Year February 22, 2001	
I hereby claim the benefit the Application Number(s):	under 35 U.S.C.119(e) of any Unite Filing I	ed States provisional appl Date(Month/Day/Year)	ication(s) listed below.	
designating the United State not disclosed in the prior U 112, I acknowledge the du	ander 35, U. S. C. 120 of any Unite tes of America, listed below and, in inted States or PCT international a sty to disclose information which is date of the prior application and the Filing Date(Mon	nsofar as the subject mater pplication in the manner is material to patentabilishe national or PCT interna-	ter of each of the claims of this approvided by the first paragraph of ty as defined in 37 CFR 1.56 where	pplication is f 35 U.S.C nich became ion.
belief are believed to be tr	atements made herein of my own ue; and further that these statement	s were made with the kn	owledge that willful false stateme	ents and the

like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the Usuch willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vasquez, Registration No. 38,647; Stuart I. Smith, Registration No. 42,159; Carol L. Druzbick, Registration No. 40,287; Anthony H.Nourse, Registration No. 46,121; and Margaret A. Burke, Registration No. 34,474, all of

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FLESHNER & KIM, LLP P. O. Box 221200 Chantilly, Virginia 20153-1200

with full power of substitution and revocation, to prosecute this application and to transact all bus. Office connected therewith, and all future correspondence should be addressed to them.	siness in	the Paten	t and Ti	ademark
***************************************	*******	******	******	******
Full name of sole or first inventor: HWANG, Seung Hoon				
Inventor's signature:	Date:	Feb. 1	٥٤ . خ	02
Residence: Seoul, Korea				
, Citizenship: Republic of Korea				
Post Office Address: Seocho Samsung Raemian 102-1501, Seocho1-dong, Seocho-gu, S				
• • • • • • • • • • • • • • • • • • • •	*******	*******	******	******
Full name of joint inventor(s): KIM, Bong Hoe				
Inventor's signature: Walk	Date:	Feb	. 15 -	2002
Residence: Kyounggi-do, Korea				
Citizenship: Republic of Korea		· · · · · · · · · · · · · · · · · · ·		
Post Office Address: Joogong Apt. 111-204, Bono-dong, Ansan-si, Kyounggi-do, Korea	******	*******	******	*****
Full name of joint inventor(s): KWON, Sung Lark				
Inventor's signature:	Date:	Feb. 1	5.200	٠,
Residence: Seoul, Korea		100		
Citizenship: Republic of Korea				
Post Office Address: Mido Apt. 308-1501 ,Banpodong, Seocho-gu, Seoul, Korea				
***************************************	******	******	*****	*****
Full name of joint inventor(s):		<del> </del>		
Inventor's signature:	Date:			<del></del>
Residence:				<del></del>
Citizenship:				
Post Office Address:	******	******	*****	*****
Full name of joint inventor(s):				
Inventor's signature:	Date:			
Residence:				
Citizenship:				
Post Office Address:		<u> </u>		